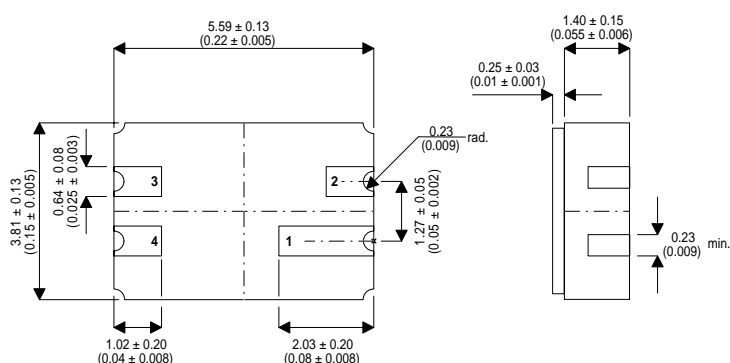


P-CHANNEL ENHANCEMENT MODE MOSFET

MECHANICAL DATA

Dimensions in mm (inches)



FEATURES

- $B_{VDSS} = 100V$
- $I_D = 300mA$
- Hermetic Surface Mount Package
- Screening Option Available

LCC3 PACKAGE Underside View

PAD 1 - Drain PAD 3 - Source
PAD 2 - N/C PAD 4 - Gate

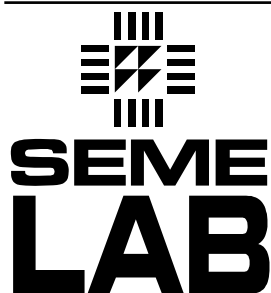
The VP1008CSM4 is a general purpose P-Channel enhancement mode mosfet in a Ceramic Surface Mount package designed for high rel applications:

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ C$ unless otherwise stated)

V_{DS}	Drain – Source Voltage		100V
V_{GS}	Gate – Source Voltage		$\pm 30V$
I_D	Continuous Drain Current	@ $T_A = 25^\circ C$	300mA
		@ $T_A = 100^\circ C$	195mA
I_{DM}	Pulsed Drain Current ¹		3A
P_D	Power Dissipation	@ $T_A = 25^\circ C$	400W
		@ $T_A = 100^\circ C$	160W
T_{STG}, T_J	Maximum Junction and Storage Temperature Range		$150^\circ C$

NOTE:

- 1) Repetitive Rating: Pulse Width limited by maximum junction temperature.



VP1008CSM4

ELECTRICAL RATINGS ($T_A = 25^\circ\text{C}$ unless otherwise stated)

Characteristic	Test Conditions	Min.	Typ.	Max.	Unit
STATIC CHARACTERISTICS					
BV_{DSS} Drain – Source Breakdown Voltage	$V_{GS} = 0V$ $I_D = -10\mu A$	-110	-100		V
$V_{GS(TH)}$ Gate Threshold Voltage	$V_{DS} = V_{GS}$ $I_D = -1mA$	-34	-2	-45	
I_{GSS} Gate – Source Leakage Current	$V_{GS} = \pm 20V$ $V_{GS} = 0V$ $T_J = 125^\circ\text{C}$			± 100 ± 500	nA
I_{DSS} Zero Gate Voltage Drain Current	$V_{DS} = -100V$ $V_{GS} = 0V$ $T_J = 125^\circ\text{C}$			-10 -500	μA
$I_{D(ON)}$ On State Drain Current ¹	$V_{DS} = -15V$ $V_{GS} = -10V$	-2	-11		A
$R_{DS(ON)}$ Static Drain – Source On-State Resistance ¹	$V_{GS} = 10V$ $I_D = -1A$	25		5	Ω
	$T_J = 125^\circ\text{C}$	43		8	
g_{fs} Forward Transconductance ¹	$V_{DS} = -10V$ $I_D = -0.5A$	325	200		mS
g_{os} Common Source Output Conductance	$V_{DS} = -7.5V$ $I_D = -0.1A$	450			μS
DYNAMIC CHARACTERISTICS					
C_{iss} Input capacitance	$V_{GS} = 0V$		38	60	pF
C_{oss} Output capacitance	$V_{DS} = 25V$		16	25	
C_{rss} Reverse transfer capacitance	$f = 1MHz$		2	5	
SWITCHING CHARACTERISTICS					
t_{on} Turn-on Time	$V_{DD} = 15V$ $R_L = 23\Omega$ $I_D = 0.6A$ $R_G = 25\Omega$		7	10	ns
t_{off} Turn-off Time	$V_{GEN} = 10V$		9	10	

NOTES:

1) Pulse Test: Pulse Width = $300\mu s$, Duty Cycle $\leq 2\%$

THERMAL CHARACTERISTICS

Characteristic	Min.	Typ.	Max.	Unit
$R_{\theta JA}$ Junction – Ambient			312.5	$^\circ\text{C/W}$